Microchip Part # (New): TC1108-xxx, TC1262/63/64/65-XXX, TC2117-XXX, TCM811/12-XXX, TC1270/71-XXX

Projected Ship Date of Revised Device: 10/15/02 for TC1262, TC1270, TCM811. 1/5/03 for others

Description of Change:

Qualify above part numbers in 3P SOT-223, 3P DDPAK, 5P DDPAK, 3P TO-220, 5P TO-220, 4P SOT-143 with Microchip process die.

Impacts to Data Sheet: None

Reason for Change:

AMI wafer source was replaced by Microchip 130k Silicon Gate process

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship ContainerMarking)

Date Code and Tracking Code on top of devices